

Tensorized Optical Neural Network Architecture

Tech ID: 33812 / UC Case 2023-531-0

ABSTRACT

Researchers at the University of California, Davis have developed a large-scale, energy-efficient, high-throughput, and compact tensorized optical neural network (TONN) exploiting the tensor-train decomposition architecture on an integrated III–V-on-silicon metal-oxide-semiconductor capacitor (MOSCAP) platform.

FULL DESCRIPTION

The technology provides a solution of using a TONN architecture to address and mitigate challenges of optical neural networks. The TONN architecture is scalable to 1024×1024 synapses and beyond, which is extremely difficult for conventional integrated ONN architectures, by using cascaded multi-wavelength small-radix (e.g., 8×8) tensor cores.

APPLICATIONS

- ▶ Computer vision
- ▶ Speech recognition
- ► Machine translations
- Medical diagnoses
- ▶ Advanced gaming
- ► Large-volume and cost-effective EPIC manufacturing

FEATURES/BENEFITS

- Scalable synapses
- ▶ Utilizes fewer Mach–Zehnder interferometers (MZIs) and fewer cascaded stages of MZIs than conventional ONNs
- ► Maintains a training accuracy for Modified National Institute of Standards and Technology handwritten digit classification tasks
- ▶ Reduces the footprint-energy compared with digital electronics ANN hardware
- ▶ Steps ahead compared with silicon photonic and phase-change material technologies
- ▶ Overcomes the limited scalability of conventional ONNs
- ▶ Reduces the dependency on the type of task, unlike CNNs
- ▶ Does away with the need for alignment of III–V diode laser chips to Silicon Photonics chips, thereby eliminating related losses and packaging complexity

PATENT STATUS

Patent Pending

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OTHER INFORMATION

KEYWORDS

neural networks, optical computing, photonic neural networks, tensor core decomposition

CATEGORIZED AS

Optics and

Photonics

► All Optics and Photonics

- Communications
 - Optical
- **▶** Computer
 - ▶ Hardware
- **▶** Imaging
 - ▶ Medical
- **▶** Semiconductors
 - Design andFabrication

➤ Sensors & Instrumentation

Scientific/Research

RELATED CASES

2023-531-0

ADDITIONAL TECHNOLOGIES BY THESE INVENTORS

- ▶ Higher-Speed and More Energy-Efficient Signal Processing Platform for Neural Networks
- Crystal Orientation Optimized Optical Frequency Shifter
- ► Hyperspectral Compressive Imaging
- ▶ Multi-Wavelength, Nanophotonic, Neural Computing System
- ► Athermal Nanophotonic Lasers
- ▶ Ultra-High Resolution Multi-Platform Heterodyne Optical Imaging
- ► Multi-Wavelength, Laser Array
- ▶ Optical Interposers for Embedded Photonics Integration
- ▶ Ultrahigh-Bandwidth Low-Latency Reconfigurable Memory Interconnects by Wavelength Routing
- ▶ Development of a CMOS-Compatible, Nano-photonic, Laser
- ► Energy Efficient and Scalable Reconfigurable All-to-All Switching Architecture
- ► Compressive High-Speed Optical Transceiver
- ► All-Optical Regenerators
- ▶ Silicon Based Chirped Grating Emitter for Uniform Power Emission
- ► Energy-Efficient All-Optical Nanophotonic Computing
- ▶ All-To-All Interconnection With Wavelength Routing Devices
- ▶ 3D Photonic and Electronic Neuromorphic Artificial Intelligence
- ▶ Adapting Existing Computer Networks to a Quantum-Based Internet Future

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